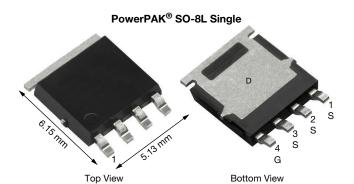


Vishay Siliconix

Automotive N-Channel 100 V (D-S) 175 °C MOSFET



PRODUCT SUMMARY				
V _{DS} (V)	100			
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 \text{ V}$	0.030			
$R_{DS(on)}(\Omega)$ at $V_{GS} = 4.5 \text{ V}$	0.035			
I _D (A)	26			
Configuration	Single			

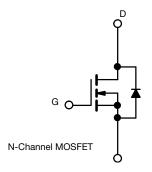
FEATURES

- TrenchFET® power MOSFET
- AEC-Q101 qualified ^d
- 100 % Rq and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912





HALOGEN FREE



ORDERING INFORMATION	
Package	PowerPAK SO-8L
Lead (Pb)-free and halogen-free	SQJ474EP (for detailed order number please see www.vishay.com/doc?79771)

ABSOLUTE MAXIMUM RATINGS ($T_C = 25$ °C, unles		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V _{DS}	100		
Gate-Source Voltage		V _{GS}	± 20	V	
Continuous Drain Current	T _C = 25 °C		26		
	T _C = 125 °C	- I _D	15		
Continuous Source Current (Diode Conduction) a		I _S	30	Α	
Pulsed Drain Current b		I _{DM}	65		
Single Pulse Avalanche Current	e Current		22		
Single Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	24	mJ	
Maximum Power Dissipation ^b	T _C = 25 °C	Б	45	W	
	T _C = 125 °C	P_{D}	15		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +175	°C	
Soldering Recommendations (Peak Temperature) e, f		-	260	-0	

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-Ambient	PCB Mount c	R_{thJA}	70	°C/W
Junction-to-Case (Drain)		R _{thJC}	3.3	G/VV

Notes

- b. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %
 c. When mounted on 1" square PCB (FR4 material)
- d. Parametric verification ongoing
- See solder profile (www.vishay.com/doc?73257). The PowerPAK SO-8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- Rework conditions: manual soldering with a soldering iron is not recommended for leadless components



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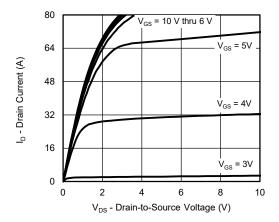
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0$, $I_D = 250 \mu A$		100	-	-	V
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	1.5	2.0	2.5	V
Gate-Source Leakage	I _{GSS}	V _{DS} =	0 V, V _{GS} = ± 20 V	-	-	± 100	nA
		$V_{GS} = 0 V$	V _{DS} = 100 V	-	-	1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V	V _{DS} = 100 V, T _J = 125 °C	-	-	50	μΑ
		V _{GS} = 0 V	V _{DS} = 100 V, T _J = 175 °C	-	-	150	1
On-State Drain Current ^a	I _{D(on)}	V _{GS} = 10 V	V _{DS} ≥ 5 V	15	-	-	Α
		V _{GS} = 10 V	I _D = 10 A	-	0.022	0.030	
Dunin Course On Chata Basistana 3		V _{GS} = 4.5 V	I _D = 5 A	-	0.026	0.035	Ω
Drain-Source On-State Resistance a	R _{DS(on)}	V _{GS} = 10 V	I _D = 10 A, T _J = 125 °C	-	-	0.052	
		V _{GS} = 10 V	I _D = 10 A, T _J = 175 °C	-	-	0.065	
Forward Transconductance b	9fs	V _{DS} = 15 V, I _D = 10 A		-	28	-	S
Dynamic ^b			<u> </u>				
Input Capacitance	C _{iss}			-	771	1100	
Output Capacitance	Coss	$V_{GS} = 0 V$	V _{DS} = 25 V, f = 1 MHz	-	397	550	pF
Reverse Transfer Capacitance	C _{rss}	7		-	27	40	•
Total Gate Charge ^c	Qg			-	14.5	30	
Gate-Source Charge ^c	Q _{gs}	V _{GS} = 10 V	$V_{DS} = 50 \text{ V}, I_D = 5 \text{ A}$	-	2.3	-	nC
Gate-Drain Charge ^c	Q _{gd}	7		-	2.8	-	•
Gate Resistance	R_{g}		f = 1 MHz	0.8	1.8	2.8	Ω
Turn-On Delay Time ^c	t _{d(on)}			-	5	10	
Rise Time ^c	t _r	V _{DD} :	= 50 V, R_L = 10 Ω	-	20	35	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 5 A$,	$V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	18	30	ns
Fall Time ^c	t _f			-	40	65	
Source-Drain Diode Ratings and Chara	acteristics ^b	•					
Pulsed Current a	I _{SM}				_	65	Α
Pulsed Current "	ISM					00	/ \

Notes

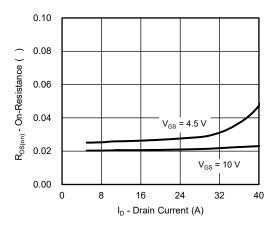
- a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

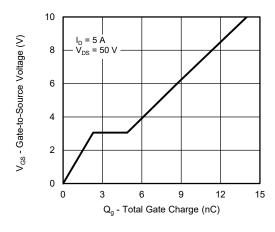




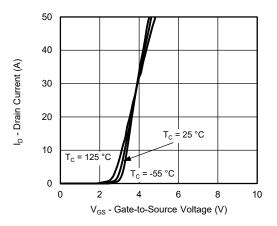
Output Characteristics



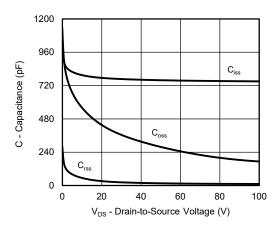
On-Resistance vs. Drain Current



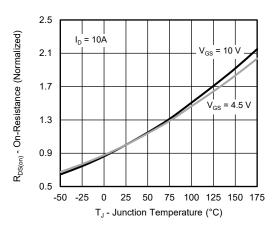
Gate Charge



Transfer Characteristics



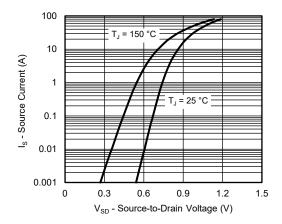
Capacitance



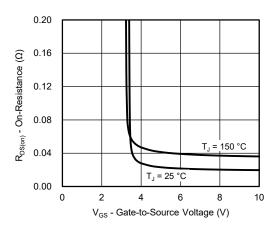
On-Resistance vs. Junction Temperature

For technical questions, contact: automoste

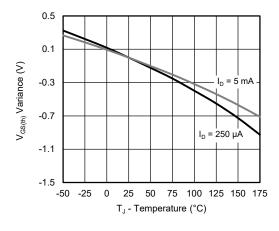




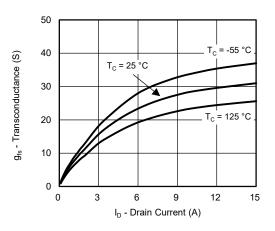
Source Drain Diode Forward Voltage



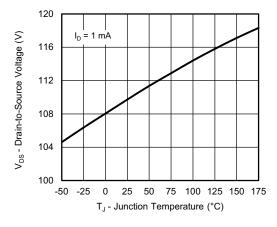
On-Resistance vs. Gate-to Source Voltage



Threshold Voltage

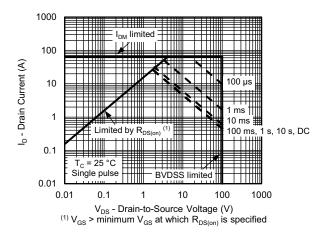


Transconductance

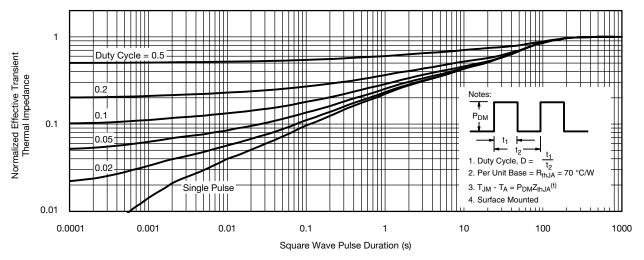


Drain Source Breakdown vs. Junction Temperature



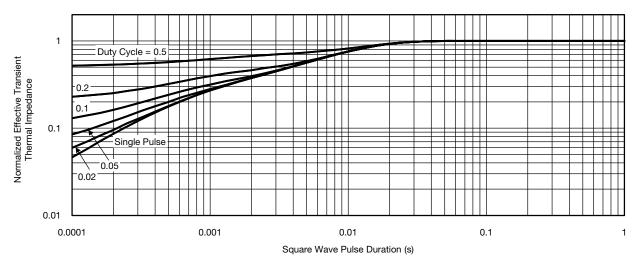


Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient





Normalized Thermal Transient Impedance, Junction-to-Case

Note

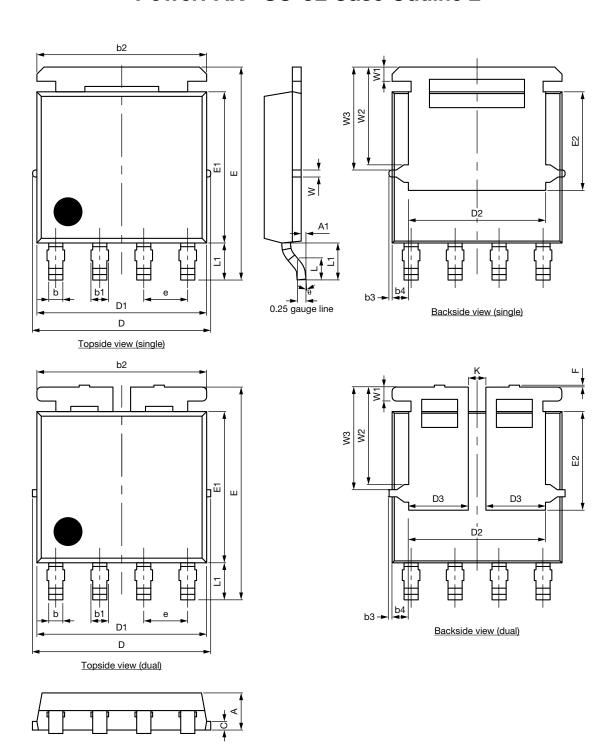
- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg276275.



PowerPAK® SO-8L Case Outline 2



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DIM.		MILLIMETERS			INCHES			
DIN.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.		
А	1.00	1.07	1.14	0.039	0.042	0.045		
A1	0.00	-	0.127	0.00	-	0.005		
b	0.33	0.41	0.48	0.013	0.016	0.019		
b1	0.44	0.51	0.58	0.017	0.020	0.023		
b2	4.80	4.90	5.00	0.189	0.193	0.197		
b3		0.094		0.004				
b4		0.47			0.019			
С	0.20	0.25	0.30	0.008	0.010	0.012		
D	5.00	5.13	5.25	0.197	0.202	0.207		
D1	4.80	4.90	5.00	0.189	0.193	0.197		
D2	3.86	3.96	4.06	0.152	0.156	0.160		
D3	1.63	1.73	1.83	0.064	0.068	0.072		
е		1.27 BSC		0.050 BSC				
Е	6.05	6.15	6.25	0.238	0.242	0.246		
E1	4.27	4.37	4.47	0.168	0.172	0.176		
E2	2.75	2.85	2.95	0.108	0.112	0.116		
F	-	-	0.15	-	-	0.006		
L	0.62	0.72	0.82	0.024	0.028	0.032		
L1	0.92	1.07	1.22	0.036	0.042	0.048		
K		0.51			0.020			
W		0.23		0.009				
W1	0.41		0.016					
W2	2.82		0.111					
W3		2.96			0.117			
θ	0°	-	10°	0°	-	10°		

ECN: C21-1498-Rev. C, 01-Nov-2021

DWG: 6044

Note

• Millimeters will govern



RECOMMENDED MINIMUM PAD FOR PowerPAK® SO-8L SINGLE



Recommended Minimum Pads Dimensions in mm (inches)



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